

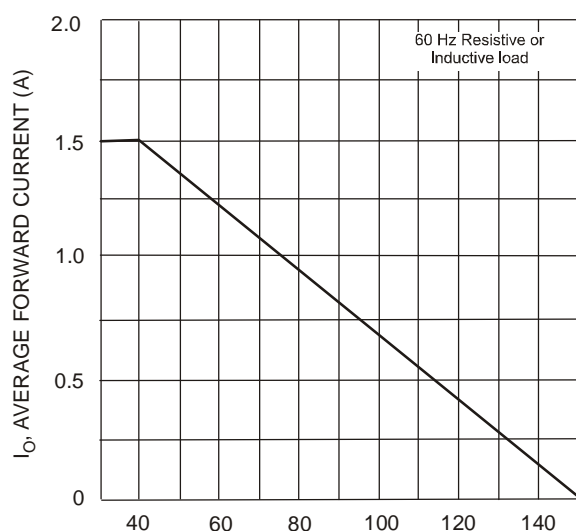
Maximum Ratings and Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

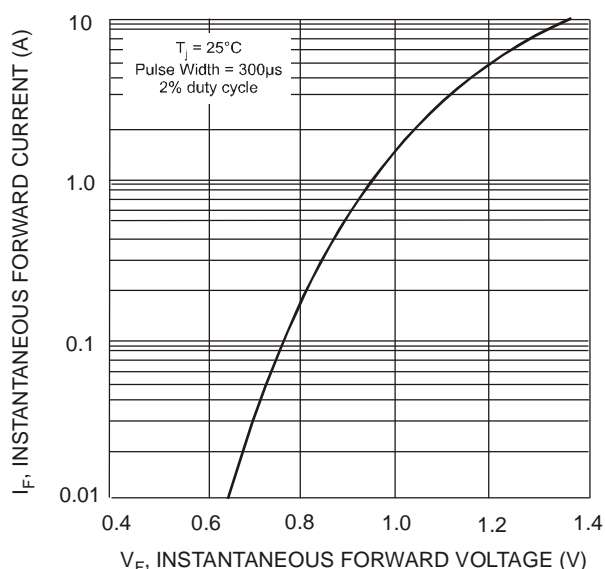
Characteristic	Symbol	DF 15005S	DF 1501S	DF 1502S	DF 1504S	DF 1506S	DF 1508S	DF 1510S	Unit
Peak Repetitive Reverse Voltage	V _{RRM}								
Working Peak Reverse Voltage	V _{RWM}	50	100	200	400	600	800	1000	V
DC Blocking Voltage	V _R								
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	580	700	V
Average Forward Rectified Current @ T _A = +40°C	I _O	1.5							A
Non-Repetitive Peak Forward Surge Current, 8.3 ms	I _{FSM}	50							A
Single Half Sine-Wave Superimposed on Rated Load									
Forward Voltage (Per Element) @ I _F = 1.5A	V _{FM}	1.1							V
Peak Reverse Current at Rated @ T _A = +25°C	I _{RM}	10							μA
DC Blocking Voltage (Per Element) @ T _A = +125°C		500							
I ² t Rating for Fusing (t<8.3ms)	I ² t	10.4							A ² s
Typical Total Capacitance per Element (Note 5)	C _T	25							pF
Typical Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	40							°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150							°C

5. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

6. Thermal resistance, junction to ambient, measured on PC board with 5.0mm² (0.03mm thick) land areas.



T_A, AMBIENT TEMPERATURE (°C)
Fig. 1 Output Current Derating Curve



V_F, INSTANTANEOUS FORWARD VOLTAGE (V)
Fig. 2 Typical Forward Characteristics (per element)

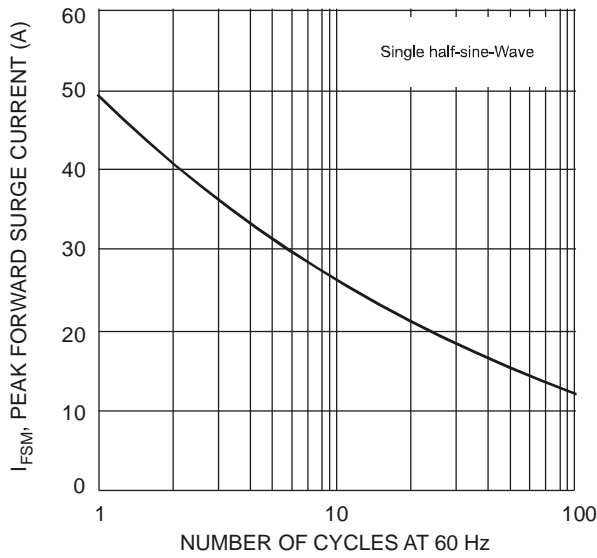


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

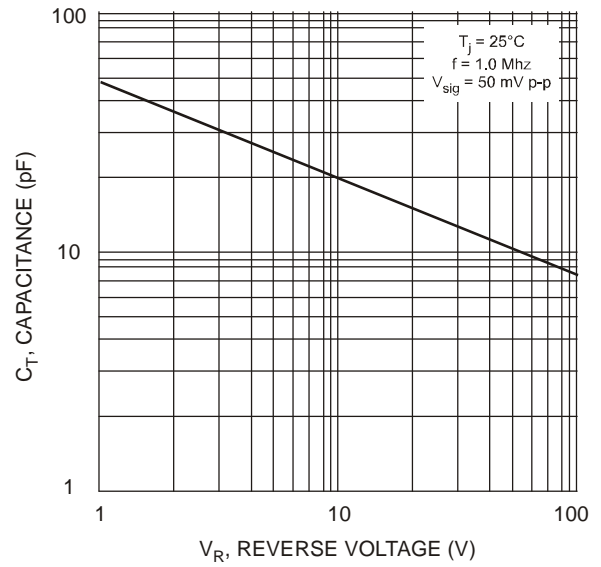


Fig. 4 Typical Total Capacitance (per element)

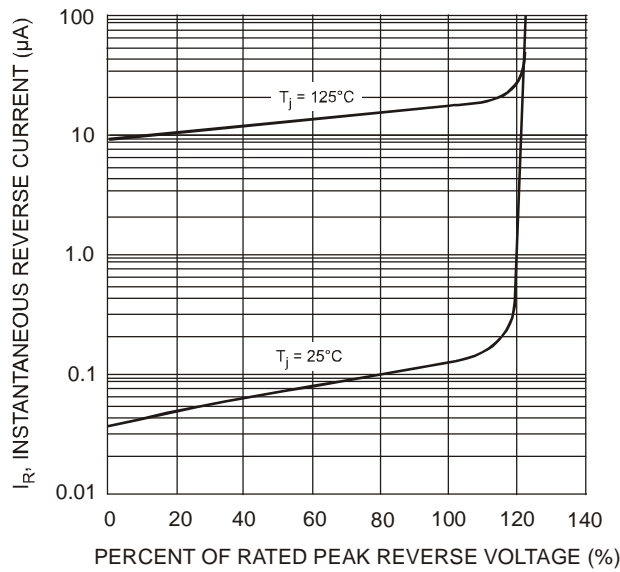
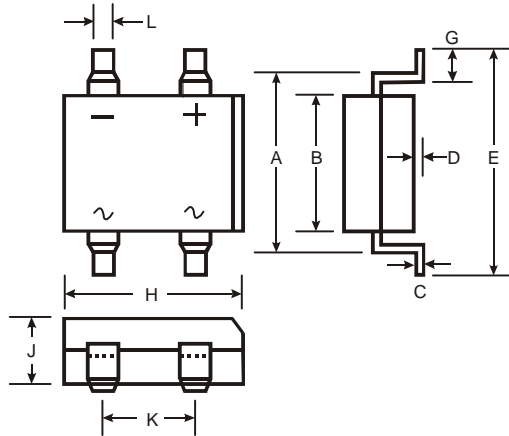


Fig. 5 Typical Reverse Characteristics (per element)

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

DF-S

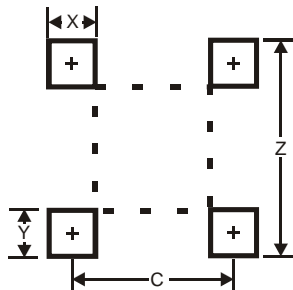


DF-S		
Dim	Min	Max
A	7.40	7.90
B	6.20	6.50
C	0.22	0.30
D	0.076	0.33
E	—	10.40
G	1.02	1.53
H	8.13	8.51
J	2.40	2.60
K	5.00	5.20
L	1.00	1.20
All Dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

DF-S



Dimensions	Value (in mm)
Z	10.26
X	1.2
Y	1.52
C	5.2

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